# Demonstration Board EPC9022/23/24/25/27/28/29/30 Quick Start Guide

Half Bridge with Gate Drive for EPC8000 Family



### DESCRIPTION

The development board is in a half bridge topology with onboard gate drives, featuring the EPC8000 family of high frequency enhancement mode ( $eGaN^{\circ}$ ) field effect transistors (FETs). The purpose of these development boards is to simplify the evaluation process of the EPC8000 family of eGaN FETs by including all the critical components on a single board that can be easily connected into any existing converter.

The development board is 2" x 1.5" and contains two *eGaN* FETs in a half bridge configuration using the Texas Instruments LM5113 gate

driver, supply and bypass capacitors. The board contains all critical components and layout for optimal switching performance. There are also various probe points to facilitate simple waveform measurement and efficiency calculation. A complete block diagram of the circuit is given in Figure 1.

For more information on the EPC8000 family of *eGaN* FETs, please refer to the datasheets available from EPC at www.epc-co.com. The datasheet should be read in conjunction with this quick start guide.

#### Table 1: Performance Summary (TA = 25°C)

YMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNITS
$V_{\text{DD}}$	Gate Drive Input Supply Range		7	12	V
		40 V devices; EPC9024, EPC9027, EPC9028		28*	V
$V_{\text{IN}}$	Bus Input Voltage Range	65 V devices; EPC9022, EPC9025, EPC9029		45*	V
		100 V devices; EPC9023, EPC9030		70*	V
V <sub>OUT</sub>	Switch Node Output Voltage	40 V devices; EPC9024, EPC9027, EPC9028		40	V
		65 V device EPC9022, EPC9025, EPC9029		65	V
		100 V devices; EPC9023, EPC9030		100	V
		40 V device EPC9024		4.4*	A
		40 V device EPC9027		3.5*	A
		40 V device EPC9028		2.2*	A
lout	Switch Node Output Current	65 V device EPC9022		1.6*	A
		65 V device EPC9025		2.2*	A
		65 V device EPC9029		3.5*	A
		100 V device EPC9023		2.2*	A
		100 V device EPC9030		3.2*	A
V <sub>PWM</sub>	PWM Logic Input Voltage Threshold	Input 'High'	3.5	6	V
		Input 'Low'	0	1.5	V
F <sub>MIN</sub>	Minimum Switching Frequency	Bootstrap Capacitor Limited	500		kHz
	Minimum 'High' State Input Pulse Width	V <sub>PWM</sub> rise and fall time < 10ns	20		ns
	Minimum 'Low' State Input Pulse Width	$V_{PWM}$ rise and fall time < 10ns	50 <sup>+</sup>		ns

+ Limited by time needed to 'refresh' high side bootstrap supply voltage.

## **Quick Start Procedure**

The development board is easy to set up to evaluate the performance of the *eGaN* FET. Refer to Figure 2 for proper connect and measurement setup and follow the procedure below:

- 1. With power off, connect the input power supply bus to  $+V_{IN}$  (J5, J6) and ground / return to -VIN (J7, J8).
- 2. With power off, connect the switch node of the half bridge OUT (J3, J4) to your circuit as required.
- 3. With power off, connect the gate drive input to  $+V_{DD}$  (J1, Pin-1) and ground return to  $-V_{DD}$  (J1, Pin-2).
- 4. With power off, connect the input PWM control signal to PWM (J2, Pin-1) and ground return to any of the remaining J2 pins.
- 5. Turn on the gate drive supply make sure the supply is between 7 V and 12 V range.
- 6. Turn on the bus voltage to the required value (do not exceed the absolute maximum voltage on V<sub>OUT</sub> as indicated in the table below:

a.	EPC9022, 65 V	d.	EPC9025, 65 V	g.	EPC9029, 65 V
b.	EPC9023, 100 V	e.	EPC9027, 40 V	h.	EPC9030, 100 V
c.	EPC9024, 40 V	f.	EPC9028, 40 V		

- 7. Turn on the controller / PWM input source and probe switching node to see switching operation.
- 8. Once operational, adjust the bus voltage and load PWM control within the operating range and observe the output switching behavior, efficiency and other parameters.
- 9. For shutdown, please follow steps in reverse.

NOTE. When measuring the high frequency content switch node (OUT), care must be taken to avoid long ground leads. Measure the switch node (OUT) by placing the oscilloscope probe tip through the large via on the switch node (designed for this purpose) and grounding the probe directly across the GND terminals provided. See Figure 3 for proper scope probe technique.

### THERMAL CONSIDERATIONS

The development board showcases the EPC8000 family of *eGaN* FET. Although the electrical performance surpasses that for traditional silicon devices, their relatively smaller size does magnify the thermal management requirements. The development board is intended for bench evaluation with low ambient temperature and convection cooling. The addition of heat-sinking and forced air cooling can significantly increase the current rating of these devices, but care must be taken to not exceed the absolute maximum die temperature of 125°C.

NOTE. The development board does not have any current or thermal protection on board.

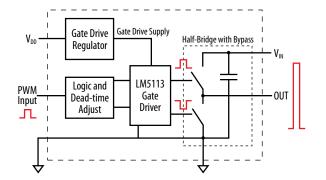


Figure 1: Block Diagram of Development Board

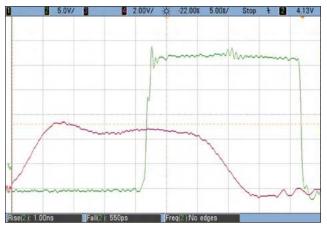


Figure 4: Typical Waveforms for  $V_{IN} = 28$  V to 3.3 V/4 A (5 MHz) Buck converter CH2: ( $V_{00T}$ ) Switch node voltage — CH4:  $V_{PWM}$  Input voltage

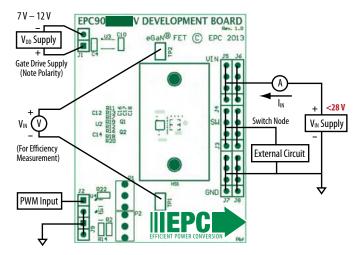


Figure 2: Proper Connection and Measurement Setup

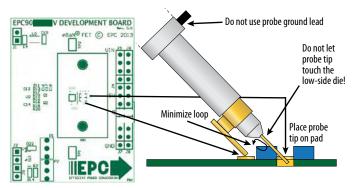


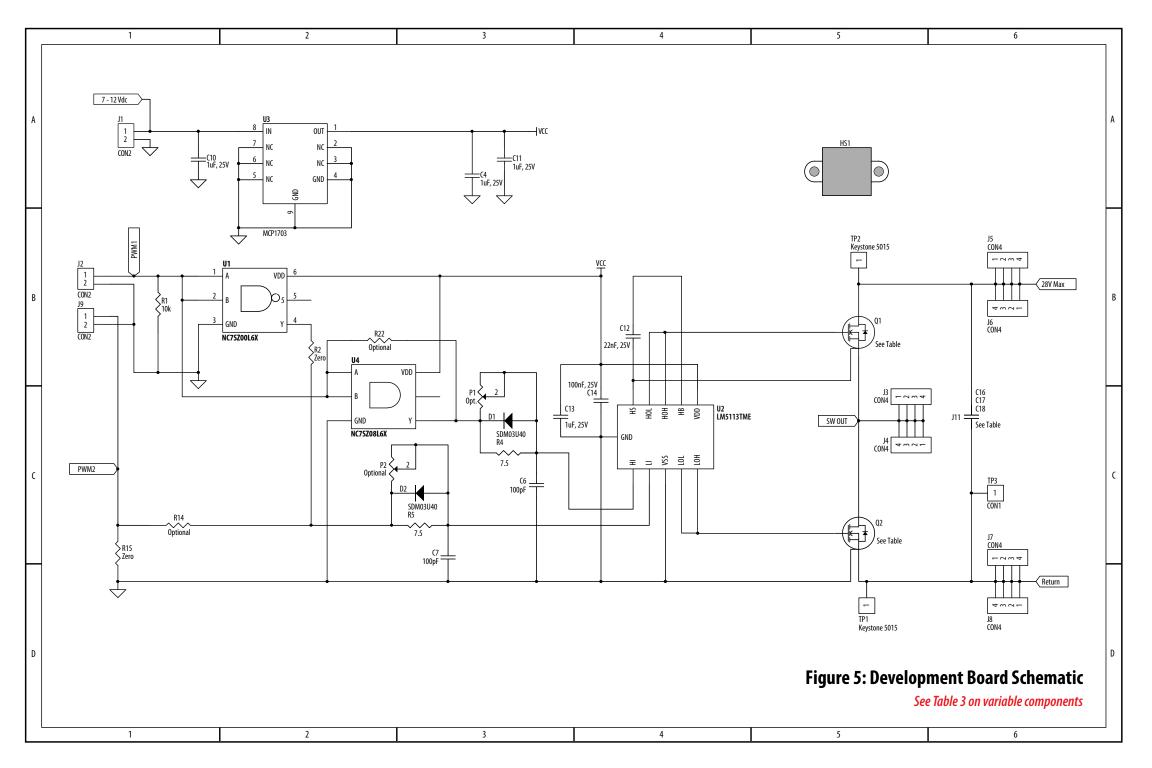
Figure 3: Proper Measurement of Switch Node – OUT

### Table 2 : Bill of Material

ltem	Qty	Reference	Part Description	Manufacturer / Part #
1	3	C4, C10, C11	Capacitor, 1uF, 10%, 25V, X5R	Murata, GRM188R61E105KA12D
2	2	C6, C7	Capacitor, 100pF, 5%, 50V, NP0	Kemet, C0402C101K5GACTU
3	1	C12	Capacitor, 22nF, 10%, 25V, X5R	TDK, C1005X5R1E223K050BA
4	1	C14	Capacitor, 0.1uF, 10%, 25V, X5R	TDK, C1005X5R1E104K
5	3	C16, C17, C18	Capacitor, - SEE TABLE 3	SEE TABLE 3
6	1	C13	Capacitor, 1uF, 10%, 25V, X5R	Murata, GRM188R61E105KA12D
7	1	C21	Capacitor, - SEE TABLE 3	SEE TABLE 3
8	2	D1, D2	Schottky Diode, 30V	Diodes Inc., SDM03U40-7
9	3	J1, J2, J9	Connector	2pins of Tyco, 4-103185-0
10	6	J3, J4, J5, J6, J7, J8	Connector	FCI, 68602-224HLF
11	2	Q1, Q2	eGaN <sup>®</sup> FET - SEE TABLE 3	SEE TABLE 3
12	1	R1	Resistor, 10.0K, 5%, 1/8W	Stackpole, RMCF0603FT10K0
13	2	R2, R15	Resistor, 0 Ohm, 1/8W	Stackpole, RMCF0603ZT0R00
14	2	R4,R5	Resistor, 7.5 Ohm, 5%, 1/16W	Stackpole, RMCF0603JT7R50
15	2	TP1, TP2	Test Point	Keystone Elect, 5015
16	1	U1	I.C., Logic	Fairchild, NC7SZ00L6X
17	1	U2	I.C., Gate driver	Texas Instruments, LM5113
18	1	U3	I.C., Regulator	Microchip, MCP1703T-5002E/MC
19	1	U4	I.C., Logic	Fairchild, NC7SZ08L6X
20	0	HS1	Optional Heatsink	HeatSink15mmX15mm
21	0	R14, R22	Optional Resistor	
22	0	P1,P2	Optional Potentiometer	PV37Y

## Table 3: Variable BOM Components

Board Number	ltem	Qty	Reference	Part Description	Manufacturer / Part #
	5	3	C16, C17, C18	Capacitor, 0.01uF, 20%, 100V, X7R	TDK, C1005X7S2A103M050BB
EPC9022	7	1	C21	Capacitor, 1uF, 10%, 100V, X7R	TDK, CGA4J3X7S2A105K125A
	11	2	Q1, Q2	eGaN® FET	EPC8002
	5	3	C16, C17, C18	Capacitor, 0.01uF, 20%, 100V, X7R	TDK, C1005X7S2A103M050BB
EPC9023	7	1	C21	Capacitor, 1uF, 10%, 100V, X7R	TDK, CGA4J3X7S2A105K125A
	11	2	Q1, Q2	eGaN® FET	EPC8003
	5	3	C16, C17, C18	Capacitor, 0.1uF, 20%, 50V, X5R	TDK, C1005X5R1H104K050BB
EPC9024	7	1	C21	Capacitor, 4.7uF, 10%, 50V, X5R	TDK, C2012X5R1H475K125AB
	11	2	Q1, Q2	eGaN® FET	EPC8004
	5	3	C16, C17, C18	Capacitor, 0.01uF, 20%, 100V, X7R	TDK, C1005X7S2A103M050BB
EPC9025	7	1	C21	Capacitor, 1uF, 10%, 100V, X7R	TDK, CGA4J3X7S2A105K125A
	11	2	Q1, Q2	eGaN® FET	EPC8005
	5	3	C16, C17, C18	Capacitor, 0.1uF, 20%, 50V, X5R	TDK, C1005X5R1H104K050BB
EPC9027	7	1	C21	Capacitor, 4.7uF, 10%, 50V, X5R	TDK, C2012X5R1H475K125AB
	11	2	Q1, Q2	eGaN® FET	EPC8007
	5	3	C16, C17, C18	Capacitor, 0.1uF, 20%, 50V, X5R	TDK, C1005X5R1H104K050BB
EPC9028	7	1	C21	Capacitor, 4.7uF, 10%, 50V, X5R	TDK, C2012X5R1H475K125AB
	11	2	Q1, Q2	eGaN® FET	EPC8008
	5	3	C16, C17, C18	Capacitor, 0.01uF, 20%, 100V, X7R	TDK, C1005X7S2A103M050BB
EPC9029	7	1	C21	Capacitor, 1uF, 10%, 100V, X7R	TDK, CGA4J3X7S2A105K125A
	11	2	Q1, Q2	eGaN® FET	EPC8009
	5	3	C16, C17, C18	Capacitor, 0.01uF, 20%, 100V, X7R	TDK, C1005X7S2A103M050BB
EPC9030	7	1	C21	Capacitor, 1uF, 10%, 100V, X7R	TDK, CGA4J3X7S2A105K125A
	11	2	Q1, Q2	eGaN® FET	EPC8010



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